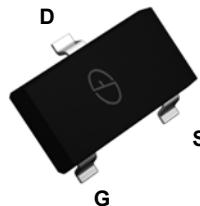
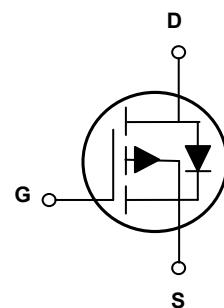


## Main Product Characteristics

BV <sub>DSS</sub>	-20V
R <sub>DS(ON)</sub>	33mΩ
I <sub>D</sub>	-5.8A



SOT-23



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFC0213 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Drain Current-Continuous (T <sub>C</sub> =25°C)	I <sub>D</sub>	-5.8	A
Drain Current-Continuous (T <sub>C</sub> =100°C)		-3.7	
Drain Current-Pulsed <sup>1</sup>	I <sub>DM</sub>	-23.2	A
Power Dissipation (T <sub>C</sub> =25°C)	P <sub>D</sub>	1.56	W
Power Dissipation-Derate above 25°C		0.012	W/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	80	°C/W
Operating Junction Temperature Range	T <sub>J</sub>	-55 To +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 To +150	°C

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-20	-	-	V
$\text{BV}_{\text{DSS}}$ Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=-1\text{mA}$	-	-0.02	-	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=-20\text{V}, V_{\text{GFS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	-1	$\mu\text{A}$
		$V_{\text{DS}}=-16\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	-10	$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 10\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 10$	$\mu\text{A}$
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-4\text{A}$	-	28	33	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-3\text{A}$	-	37	45	
		$V_{\text{GS}}=-1.8\text{V}, I_{\text{D}}=-2\text{A}$	-	49	65	
		$V_{\text{GS}}=-1.5\text{V}, I_{\text{D}}=-2\text{A}$	-	56	80	
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=-250\mu\text{A}$	-0.3	-0.6	-1	V
$V_{\text{GS(th)}}$ Temperature Coefficient	$\Delta V_{\text{GS(th)}}$		-	2	-	$\text{mV}/^\circ\text{C}$
Forward Transconductance	$g_{\text{fs}}$	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-3\text{A}$	-	8.4	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>2,3</sup>	$Q_g$	$V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-4\text{A}$ $V_{\text{GS}}=-4.5\text{V}$	-	16.1	25	nC
Gate-Source Charge <sup>2,3</sup>	$Q_{\text{gs}}$		-	1.8	3	
Gate-Drain Charge <sup>2,3</sup>	$Q_{\text{gd}}$		-	3.8	7	
Turn-On Delay Time <sup>2,3</sup>	$t_{\text{d(on)}}$	$V_{\text{DD}}=-10\text{V}, R_{\text{G}}=25\Omega$ $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-1\text{A}$	-	8.2	16	nS
Rise Time <sup>2,3</sup>	$t_r$		-	30	57	
Turn-Off Delay Time <sup>2,3</sup>	$t_{\text{d(off)}}$		-	71.1	135	
Fall Time <sup>2,3</sup>	$t_f$		-	19.8	38	
Input Capacitance	$C_{\text{iss}}$		-	1440	2100	pF
Output Capacitance	$C_{\text{oss}}$	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$	-	155	230	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	115	170	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_s$	$V_G=V_D=0\text{V},$ Force Current	-	-	-5.8	A
Pulsed Source Current	$I_{\text{SM}}$		-	-	-23.2	A
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-1\text{A}, T_J=25^\circ\text{C}$	-	-	-1	V

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

## Typical Electrical and Thermal Characteristic Curves

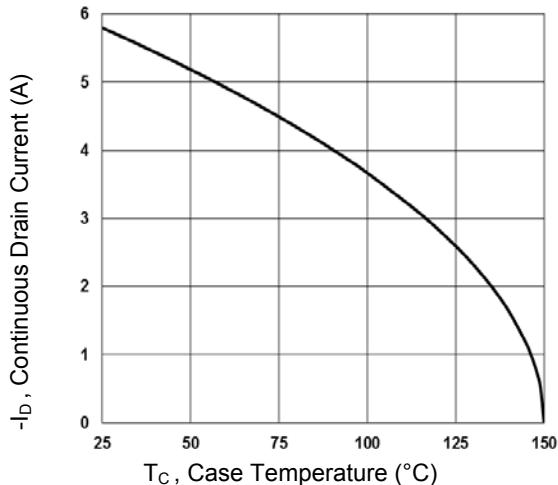


Figure 1. Continuous Drain Current vs.  $T_c$

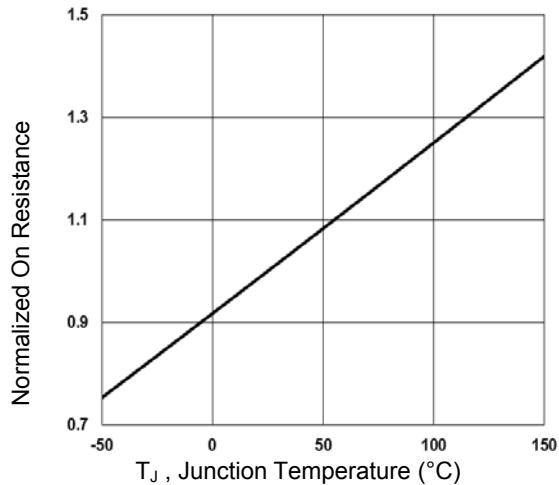


Figure 2. Normalized  $R_{DS(on)}$  vs.  $T_j$

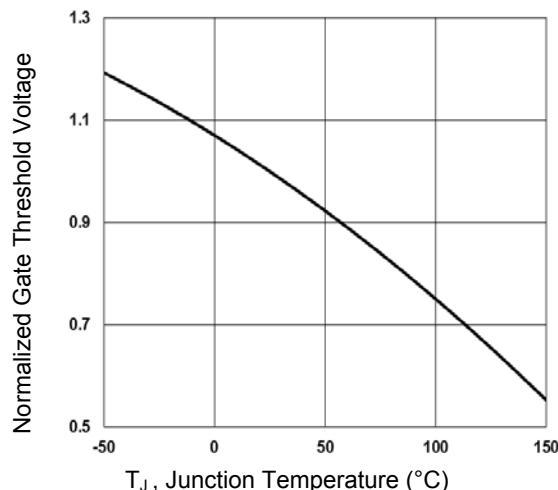


Figure 3. Normalized  $V_{th}$  vs.  $T_j$

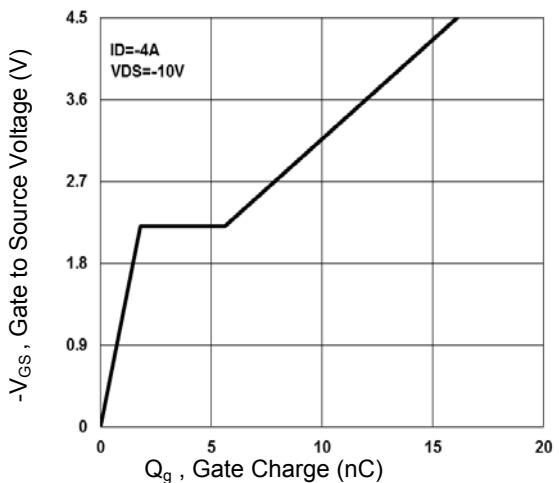


Figure 4. Gate Charge Waveform

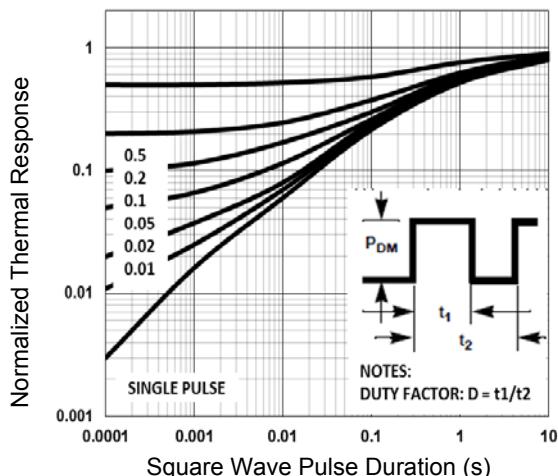


Figure 5. Normalized Transient Impedance

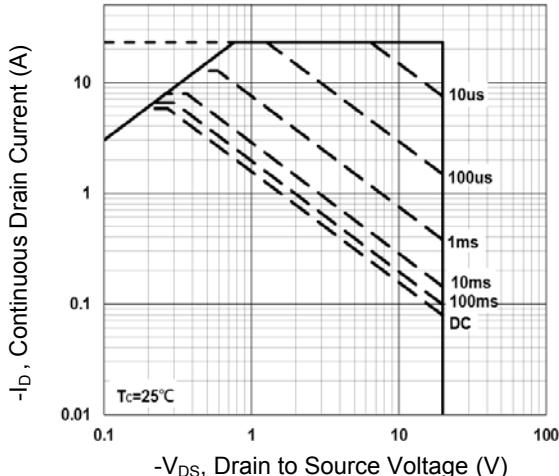


Figure 6. Maximum Safe Operation Area

### Typical Electrical and Thermal Characteristic Curves

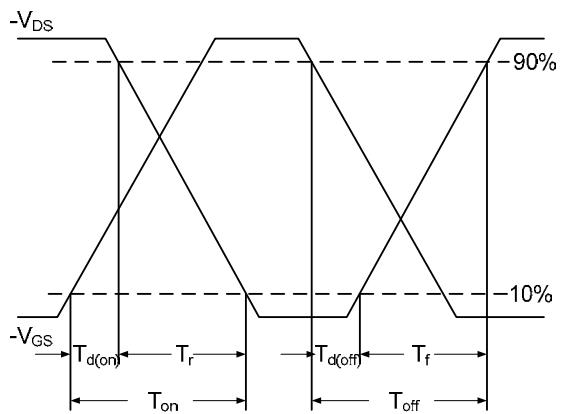


Figure 7. Switching Time Waveform

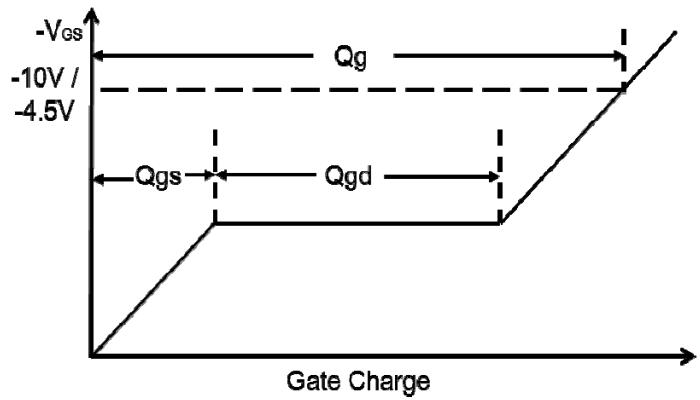
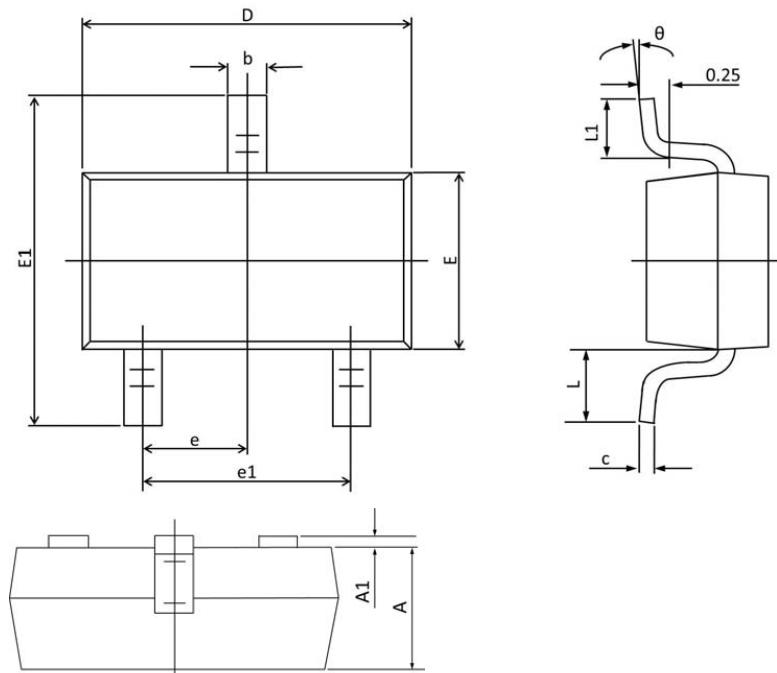


Figure 8. Gate Charge Waveform

## Package Outline Dimensions      SOT-23



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.900	1.000	0.035	0.039
A1	0.000	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
c	0.090	0.110	0.003	0.004
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	1°	7°	1°	7°

## Order Information

Device	Package	Marking	Carrier	Quantity	HSF Status
GSFC0213	SOT-23	b	Tape & Reel	3,000 pcs / Reel	RoHS Compliant